TOSHIBA

TLP3061F(S),TLP3062F(S),TLP3063F(S) TOSHIBA PHOTOCOUPLER IRED & PHOTO-TRIAC

TLP3061F(S),TLP3062F(S),TLP3063F(S)

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

Unit: mm 10.16±0.25 7.62±0.25 15±0 0 to 12 2,54±0.25 JEDEC JEITA TOSHIBA 11-7A902S

weight: 0.39g (typ.)

The TOSHIBA TLP3061F(S), TLP3062F(S), TLP3063F(S) consist of a zero voltage crossing turn-on photo-triac optically coupled to an infrared emitting diode in a six lead plastic DIP package.

- Peak Off-State Voltage : 600 V (min)
- Trigger LED Current
- : 15 mA (max) (TLP3061F(S)) 10 mA (max) (TLP3062F(S)) 5 mA (max) (TLP3063F(S))
- **On-State** Current
- Isolation Voltage
- UL-recognized
- cUL-recognized
- : UL 1577, File No.E67349
- : CSA Component Acceptance Service No.5A File No.E67349

: 100 mA (max)

: 5000 Vrms (min)

- CQC-approved VDE-approved
- : GB4943.1,GB8898 Japan Factory : EN 60747-5-5, EN 62368-1 (Note1)

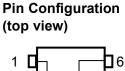
Note 1 : When a VDE approved type is needed, please designate the Option (D4).

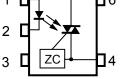
Construction mechanical rating 10.16 mm pitch TLPxxxxF type 8.0 mm (Min) C Č

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sulation Thickness	
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Ir

8.0 mm (Min) 0.5 mm (Min)





1: Anode 2: Cathode 3: N.C. 4:Terminal 1 6:Terminal 2

ZC:Zero-cross Circuit

Start of commercial production 1996-09

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit	
	Forward current		lF	50	mA	
	Forward current derating (Ta ≥ 53°	ΔI _F / °C	-0.7	mA / °C		
	Peak forward current (100 μs pulse, 100 pps)	IFP	1	A		
LED	Power dissipation	PD	100	mW		
	Power dissipation derating (Ta ≥ 5	ΔP _D /°C	-1.4	mW / °C	\sum	
	Reverse voltage		VR	5	V	\sum
	Junction temperature	Tj	125	$\left(\circ c \right)$		
	Off-state output terminal voltage		VDRM	600	\mathbb{V})
	On-state RMS current	Ta = 25°C Ta = 70°C	I _{T(RMS)}	100 50	mA	
	On-state current derating (Ta ≥ 25	5°C)	ΔI _T / °C	-1,1	mA/°C	\bigcirc
Detector	Peak on–state current (100μs pulse, 120 pps)		ITP	2	A	
Ğ	Peak nonrepetitive surge current (P _w = 10 ms)				A	\bigcirc
	Power dissipation	PD	300	mW		
	Power dissipation derating (Ta \ge 2	ΔP _D /°C	-4.0	m₩/ᡗ°℃		
	Junction temperature	<u> </u>	115	°C	\mathbf{D}	
Storage temperature range			Tstg	-55 to 150	°°C ∠	
Operating temperature range			Topr	–40 to 100 ((°€	
Lead soldering temperature (10 s)			T _{sol}	260	ç	
Total p	ackage power dissipation		PT	330	mW	
Total p (Ta ≥ 2	ackage power dissipation derating 25°C)		ΔPT / °C	4.4	mW / °C	
	on voltage 0 s., R.H.≤ 60 %)	(Note 1)	BVs	5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	VAC	—	—	240	Vac
Forward current	IF*	15	20	25	mA
Peak on-state current	ITP	—	—	1	А
Operating temperature	T _{opr}	-25		85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

* In the case of TLP3062

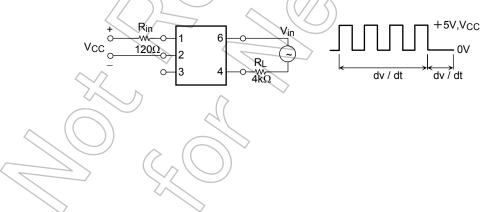
Individual Electrical Characteristics (Ta = 25°C)

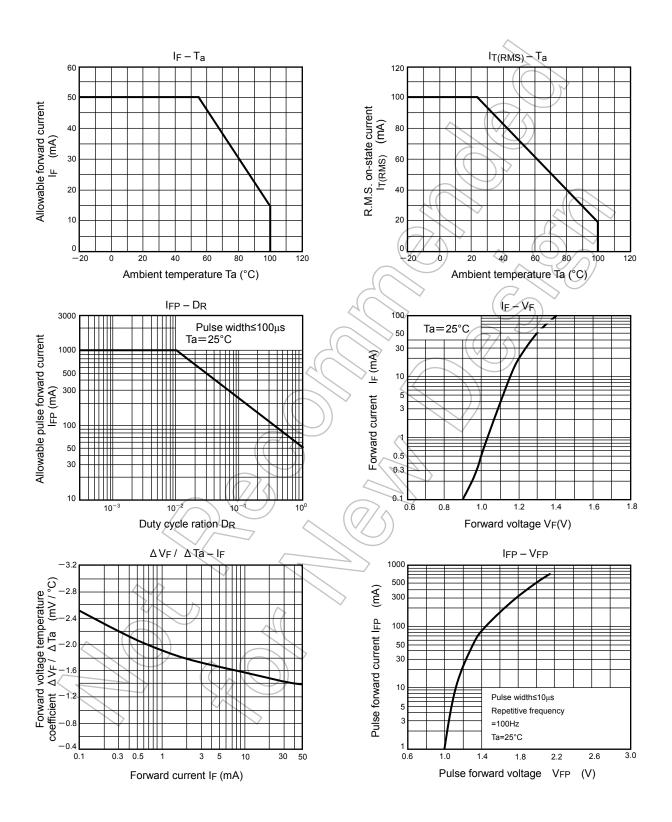
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I _R	V _R = 5 V	_	—	10	μA
	Capacitance	Ст	V = 0 V, f = 1 MHz	γ	10	_	pF
Detector	Peak off-state current	IDRM	V _{DRM} = 600 V		10	1000	nA
	Peak on-state voltage	VTM	I _{TM} = 100 mA		1.7	3.0	V
	Holding current	lΗ	6) /<	0.6	_	mA
	Critical rate of rise of off-state voltage	dv / dt	V _{in} = 240 Vrms, Ta = 85 °C (Fig.1)	200	500	_	V / μs
	Critical rate of rise of commutating voltage	dv / dt (c)	V _{in} = 60 Vrms, I _T = 15 mA (Eig.1)	_	0.2	_	V / μs

Coupled Electrical Characteristics (Ta = 25°C)

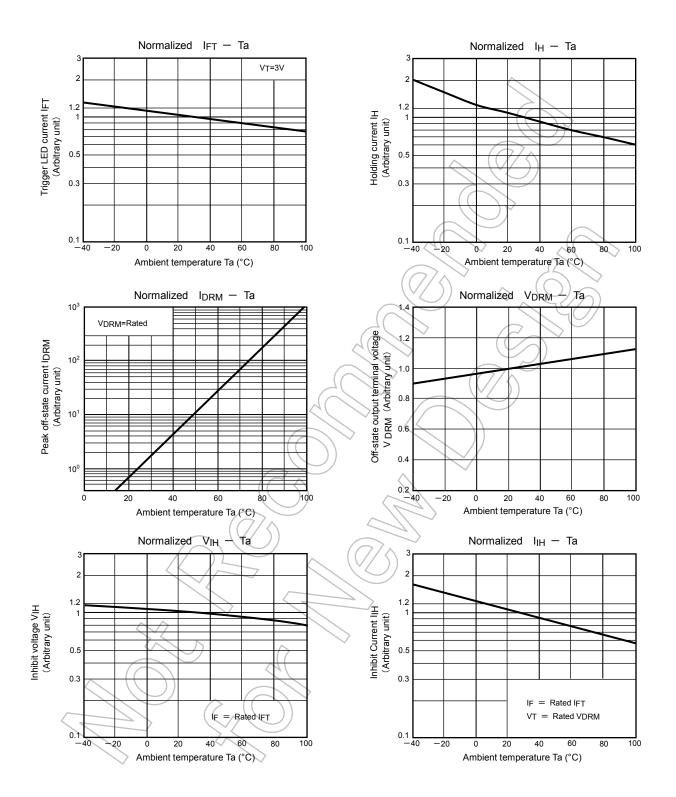
Characteris	stic	Symbol	Test Condition	Min.	тур.	Max.	Unit
	TLP3061F(S)			\sim	, Y	15	
Trigger LED current	TLP3062F(S)	IFT	$V_T = 3V$		5	10	mA
	TLP3063F(S)			\mathbb{R}^{2}	—	5	
Inhibit voltage		VIH	IF = rated IFT	<u> </u>	—	50	V
Leakage in inhibited state	I.	Ін	IF = rated IFT VT = rated VDRM	_	100	300	μA
Capacitance input to outp	ut	es	V _S = 0 V, f = 1 MHz	-	0.8	_	pF
Isolation resistance		Rs	V _S = 500 V , R.H.≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	(BVs	AC, 60 s	5000	_	_	Vrms

dv / dt test circuit Fig. 1





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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